



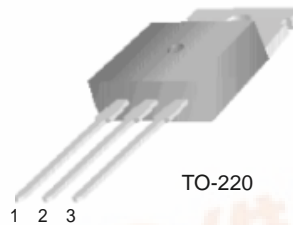
FYP1004DN

Features

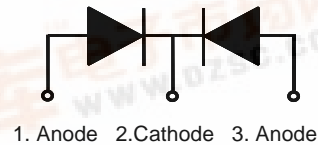
- Low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

Applications

- Switched mode power supply
- Freewheeling diodes



TO-220



SCHOTTKY BARRIER RECTIFIER

Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	40	V
V_R	Maximum DC Reverse Voltage	40	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 137^{\circ}\text{C}$	10	A
I_{FSM}	Non-repetitive Peak Surge Current (per diode) 60Hz Single Half-Sine Wave	80	A
T_J, T_{STG}	Operating Junction and Storage Temperature	-65 to +150	$^{\circ}\text{C}$

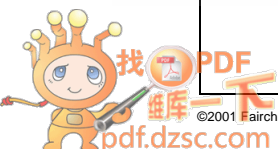
Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case (per diode)	3.0	$^{\circ}\text{C/W}$

Electrical Characteristics (per diode)

Symbol	Parameter	Value	Units
$V_{FM} *$	Maximum Instantaneous Forward Voltage		V
	$I_F = 5\text{A}$ $T_C = 25^{\circ}\text{C}$	0.55	
	$I_F = 5\text{A}$ $T_C = 125^{\circ}\text{C}$	0.49	
	$I_F = 10\text{A}$ $T_C = 25^{\circ}\text{C}$	0.67	
	$I_F = 10\text{A}$ $T_C = 125^{\circ}\text{C}$	0.65	
$I_{RM} *$	Maximum Instantaneous Reverse Current @ rated V_R		mA
	$T_C = 25^{\circ}\text{C}$	1	
	$T_C = 125^{\circ}\text{C}$	40	

* Pulse Test: Pulse Width=300 μs , Duty Cycle=2%



Typical Characteristics

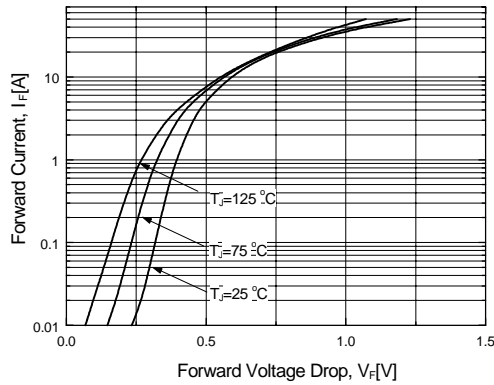


Figure 1. Typical Forward Voltage Characteristics (per diode)

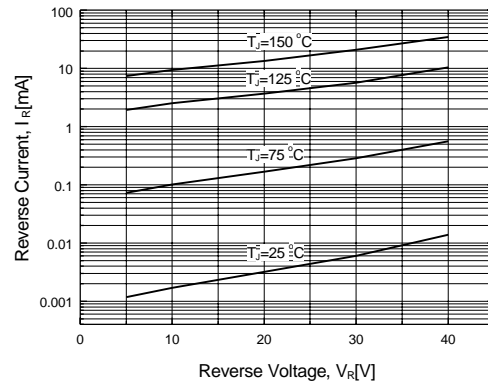


Figure 2. Typical Reverse Current vs. Reverse Voltage (per diode)

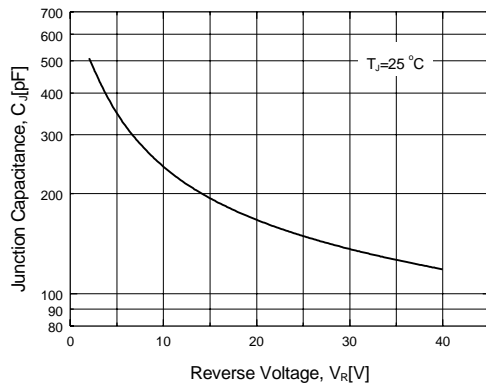


Figure 3. Typical Junction Capacitance (per diode)

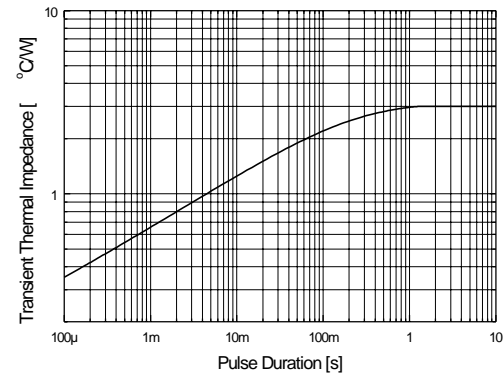


Figure 4. Thermal Impedance Characteristics (per diode)

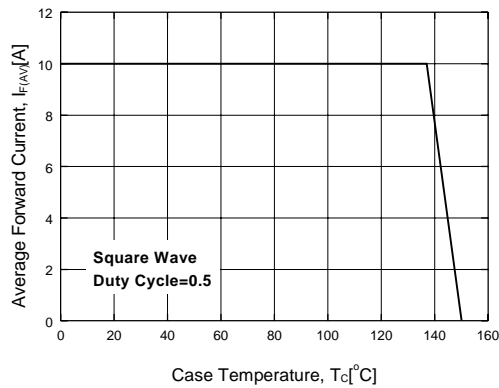


Figure 5. Forward Current Derating Curve

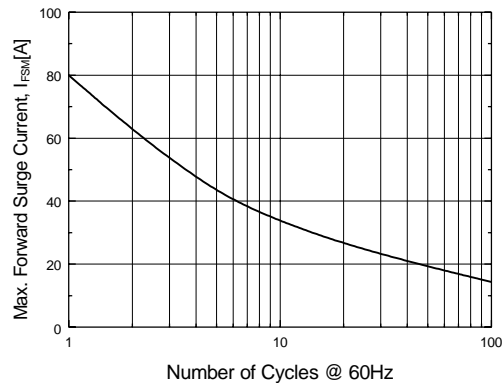
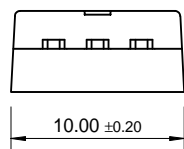
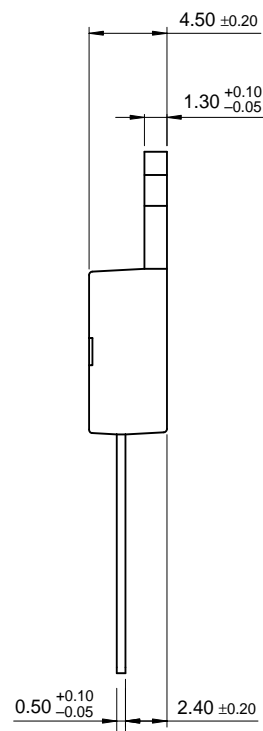


Figure 6. Non-Repetitive Sureg Current (per diode)

Technical drawing of a 2.54TYP connector. The drawing shows a side view of the component with various dimensions in millimeters. The overall width is 9.90 ±0.20 mm, with a central section width of 8.70 mm. The top section has a diameter of 3.60 ±0.10 mm. The total height is 18.95 MAX. mm, with a main body height of 15.90 ±0.20 mm. The bottom section has a height of 10.08 ±0.30 mm. The drawing also shows a 45° chamfer on the bottom edge and a 0.80 ±0.10 mm dimension for the bottom flange. The drawing is labeled 2.54TYP and [2.54 ±0.20].



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